

MC10E131, MC100E131

5V ECL 4-Bit D Flip-Flop

The MC10E/100E131 is a quad master-slave D-type flip-flop with differential outputs. Each flip-flop may be clocked separately by holding Common Clock (C_C) LOW and using the Clock Enable ($\overline{CE}$) inputs for clocking. Common clocking is achieved by holding the $\overline{CE}$ inputs LOW and using C_C to clock all four flip-flops. In this case, the $\overline{CE}$ inputs perform the function of controlling the common clock, to each flip-flop.

Individual asynchronous resets are provided (R). Asynchronous set controls (S) are ganged together in pairs, with the pairing chosen to reflect physical chip symmetry.

Data enters the master when both C_C and $\overline{CE}$ are LOW, and transfers to the slave when either C_C or $\overline{CE}$ (or both) go HIGH.

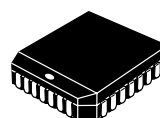
The 100 Series contains temperature compensation.

- 1100 MHz Min. Toggle Frequency
- Differential Outputs
- Individual and Common Clocks
- Individual Resets (asynchronous)
- Paired Sets (asynchronous)
- PECL Mode Operating Range: $V_{CC} = 4.2\text{ V}$ to 5.7 V with $V_{EE} = 0\text{ V}$
- NECL Mode Operating Range: $V_{CC} = 0\text{ V}$ with $V_{EE} = -4.2\text{ V}$ to -5.7 V
- Internal Input $50\text{ K}\Omega$ Pulldown Resistors
- Metastability Time Constant is 200 ps.
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- ESD Protection: $> 2\text{ KV HBM}$, $> 200\text{ V MM}$
- Moisture Sensitivity Level 1
For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 240 devices



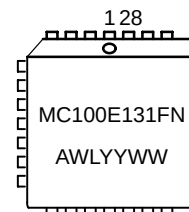
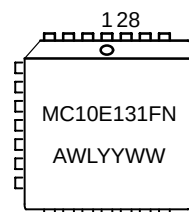
ON Semiconductor®

<http://onsemi.com>



**PLCC-28
FN SUFFIX
CASE 776**

MARKING DIAGRAMS



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10E131FN	PLCC-28	37 Units/Rail
MC10E131FNR2	PLCC-28	500 / Tape & Reel
MC100E131FN	PLCC-28	37 Units/Rail
MC100E131FNR2	PLCC-28	500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC10E131, MC100E131

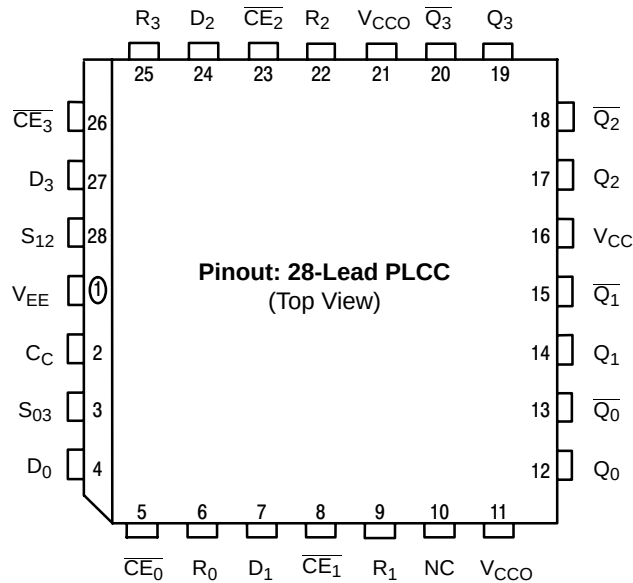


Figure 1. Pinout Diagram

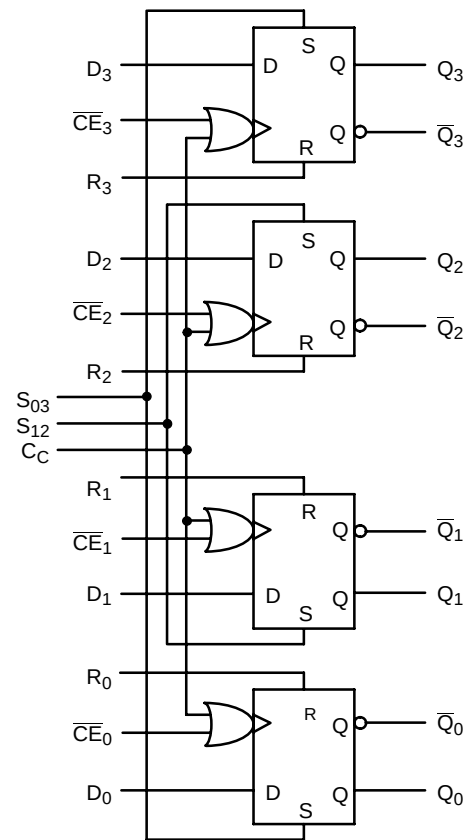


Figure 2. Logic Diagram

PIN DESCRIPTION

PIN	FUNCTION
$D_0 - D_3$	ECL Data Inputs
$\overline{CE}_0 - \overline{CE}_3$	ECL Clock Enables (Individual)
$R_0 - R_3$	ECL Resets
C_C	ECL Common Clock
S_{03}, S_{12}	ECL Sets (paired)
$Q_0 - Q_3, \overline{Q}_0 - \overline{Q}_3$	ECL Differential Outputs
V_{CC}, V_{CCO}	Positive Supply
V_{EE}	Negative Supply
NC	No Connect

MC10E131, MC100E131

MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-8	V
V _I	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	V _I ≤ V _{CC} V _I ≥ V _{EE}	6 -6	V V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ _{JA}	Thermal Resistance (Junction-to-Ambient)	0 LFPM 500 LFPM	28 PLCC 28 PLCC	63.5 43.5	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction-to-Case)	std bd	28 PLCC	22 to 26	°C/W
V _{EE}	PECL Operating Range NECL Operating Range			4.2 to 5.7 -5.7 to -4.2	V V
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

1. Maximum Ratings are those values beyond which device damage may occur.

10E SERIES PECL DC CHARACTERISTICS V_{CCx} = 5.0 V; V_{EE} = 0.0 V (Note 2)

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I _{EE}	Power Supply Current		58	70		58	70		58	70		58	70	mA
V _{OH}	Output HIGH Voltage (Note 3)				3980	4070	4160	4020	4105	4190	4090	4185	4280	mV
V _{OL}	Output LOW Voltage (Note 3)				3050	3210	3370	3050	3210	3370	3050	3227	3405	mV
V _{IH}	Input HIGH Voltage				3830	3995	4160	3870	4030	4190	3940	4110	4280	mV
V _{IL}	Input LOW Voltage				3050	3285	3520	3050	3285	3520	3050	3302	3555	mV
I _{IH}	Input HIGH Current C _C S R, $\overline{CE}$ D			350 450 300 150			350 450 300 150			350 450 300 150			350 450 300 150	μA
I _{IL}	Input LOW Current				0.5	0.3		0.5	0.25		0.3	0.2		μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary -0.46 V / +0.06 V.
- Outputs are terminated through a 50 ohm resistor to V_{CC}-2 volts.

MC10E131, MC100E131

10E SERIES NECL DC CHARACTERISTICS $V_{CCx} = 0.0\text{ V}$; $V_{EE} = -5.0\text{ V}$ (Note 4)

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		58	70		58	70		58	70		58	70	mA
V_{OH}	Output HIGH Voltage (Note 5)				-1020	-930	-840	-980	-895	-810	-910	-815	-720	mV
V_{OL}	Output LOW Voltage (Note 5)				-1950	-1790	-1630	-1950	-1790	-1630	-1950	-1773	-1595	mV
V_{IH}	Input HIGH Voltage				-1170	-1005	-840	-1130	-970	-810	-1060	-890	-720	mV
V_{IL}	Input LOW Voltage				-1950	-1715	-1480	-1950	-1715	-1480	-1950	-1698	-1445	mV
I_{IH}	Input HIGH Current C _C S R, $\overline{CE}$ D			350 450 300 150			350 450 300 150			350 450 300 150			350 450 300 150	μA
I_{IL}	Input LOW Current				0.5	0.3		0.5	0.065		0.3	0.2		μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

4. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $-0.46\text{ V} / +0.06\text{ V}$.
5. Outputs are terminated through a 50 ohm resistor to $V_{CC}-2$ volts.

100E SERIES PECL DC CHARACTERISTICS $V_{CCx} = 5.0\text{ V}$; $V_{EE} = 0.0\text{ V}$ (Note 6)

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		58	70		58	70		58	70		67	81	mA
V_{OH}	Output HIGH Voltage (Note 7)				3975	4050	4120	3975	4050	4120	3975	4050	4120	mV
V_{OL}	Output LOW Voltage (Note 7)				3190	3295	3380	3190	3255	3380	3190	3260	3380	mV
V_{IH}	Input HIGH Voltage		3975		3835	3975	4120	3835	3975	4120	3835	3975	4120	mV
V_{IL}	Input LOW Voltage		3355		3190	3355	3525	3190	3355	3525	3190	3355	3525	mV
I_{IH}	Input HIGH Current C _C S R, $\overline{CE}$ D			350 450 300 150			350 450 300 150			350 450 300 150			350 450 300 150	μA
I_{IL}	Input LOW Current				0.5	0.3		0.5	0.25		0.5	0.2		μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

6. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $-0.46\text{ V} / +0.8\text{ V}$.
7. Outputs are terminated through a 50 ohm resistor to $V_{CC} - 2\text{ V}$.

MC10E131, MC100E131

100E SERIES NECL DC CHARACTERISTICS $V_{CCx} = 0.0\text{ V}$; $V_{EE} = -5.0\text{ V}$ (Note 8)

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		58	70		58	70		58	70		67	81	mA
V_{OH}	Output HIGH Voltage (Note 9)				-1025	-950	-880	-1025	-950	-880	-1025	-950	-880	mV
V_{OL}	Output LOW Voltage (Note 9)				-1810	-1705	-1620	-1810	-1745	-1620	-1810	-1740	-1620	mV
V_{IH}	Input HIGH Voltage		-1025		-1165	-1025	-880	-1165	-1025	-880	-1165	-1025	-880	mV
V_{IL}	Input LOW Voltage		-1645		-1810	-1645	-1475	-1810	-1645	-1475	-1810	-1645	-1475	mV
I_{IH}	Input HIGH Current C_C S $R, \overline{CE}$ D			350 450 300 150			350 450 300 150			350 450 300 150			350 450 300 150	μA
I_{IL}	Input LOW Current				0.5	0.3		0.5	0.25		0.5	0.2		μA

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established.

The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

8. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary $-0.46\text{ V} / +0.8\text{ V}$.

9. Outputs are terminated through a 50 ohm resistor to $V_{CC} - 2\text{ V}$.

AC CHARACTERISTICS $V_{CCx} = 5.0\text{ V}$; $V_{EE} = 0.0\text{ V}$ or $V_{CCx} = 0.0\text{ V}$; $V_{EE} = -5.0\text{ V}$ (Note 8)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{MAX}	Maximum Toggle Frequency	1100	1400		1100	1400		1100	1400		MHz
t_{PLH} t_{PHL}	Propagation Delay to Output C_C R S	310 275 300 300	600 600 625 550	750 725 775 775	360 325 350 350	500 500 550 550	700 675 725 725	360 325 350 350	500 500 550 550	700 675 725 725	ps
t_S	Setup Time (Note 11) D	200	20		150	20		150	20		ps
t_H	Hold Time (Note 11) D	225	-20		175	-20		175	-20		ps
t_{RR}	Reset Recovery Time	450	150		400	150		400	150		ps
t_{PW}	Minimum Pulse Width R, S CLK	400 400			400 400			400 400			ps
t_{SKEW}	Within-Device Skew (Note 12)		60			60			60		ps
t_{JITTER}	Random Clock Jitter		< 1			< 1			< 1		ps
t_r/t_f	Rise/Fall Time (20–80%)	275	460	725	300	480		300	480	675	ps

10. 10 Series: V_{EE} can vary $-0.46\text{ V} / +0.06\text{ V}$.

100 Series: V_{EE} can vary $-0.46\text{ V} / +0.8\text{ V}$.

11. Setup/hold times guaranteed for both C_C and $\overline{CE}$.

12. Within-device skew is defined as identical transitions on similar paths through a device.

MC10E131, MC100E131

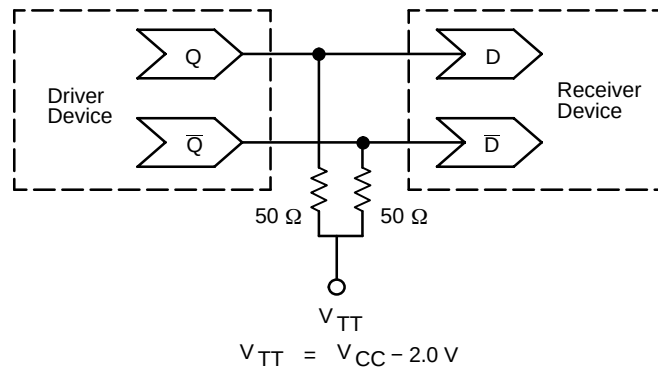


Figure 3. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020 – Termination of ECL Logic Devices.)

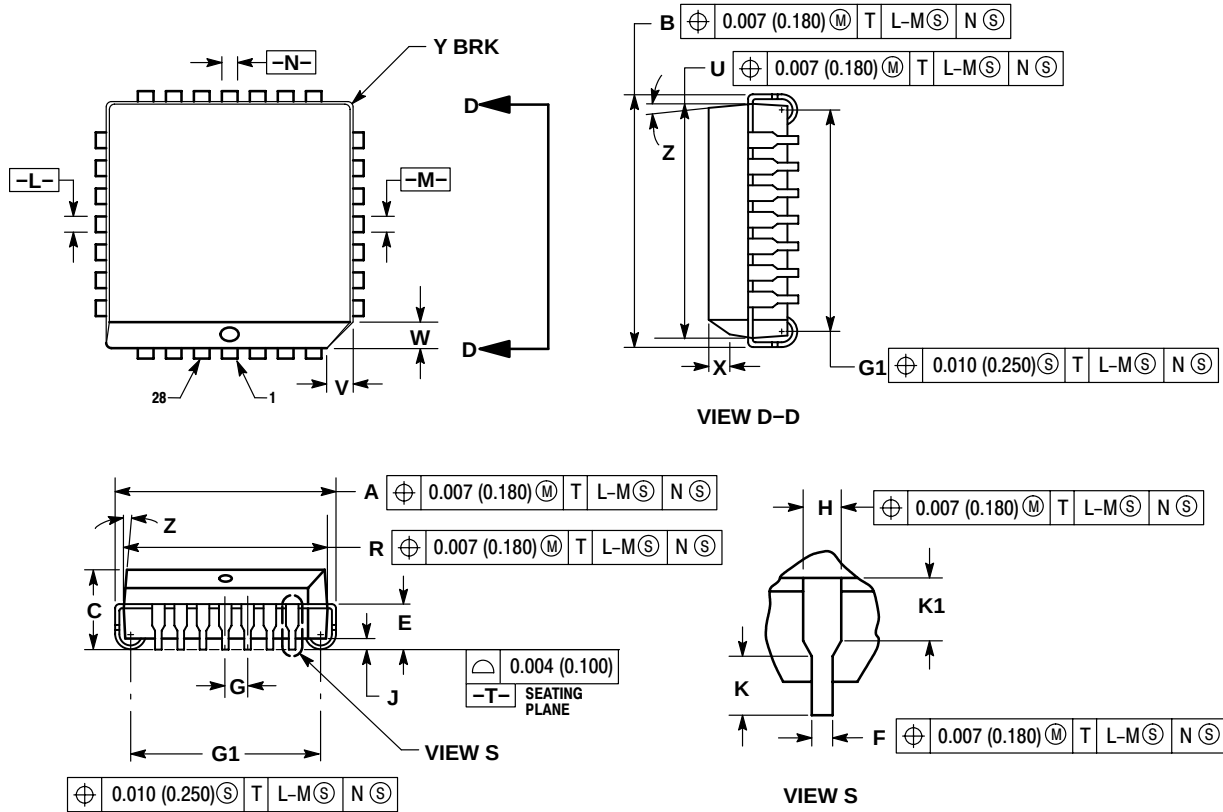
Resource Reference of Application Notes

AN1404	– ECLinPS Circuit Performance at Non-Standard V_{IH} Levels
AN1405	– ECL Clock Distribution Techniques
AN1406	– Designing with PECL (ECL at +5.0 V)
AN1503	– ECLinPS I/O SPICE Modeling Kit
AN1504	– Metastability and the ECLinPS Family
AN1568	– Interfacing Between LVDS and ECL
AN1596	– ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
AN1650	– Using Wire-OR Ties in ECLinPS Designs
AN1672	– The ECL Translator Guide
AND8001	– Odd Number Counters Design
AND8002	– Marking and Date Codes
AND8020	– Termination of ECL Logic Devices

MC10E131, MC100E131

PACKAGE DIMENSIONS

PLCC-28
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776-02
ISSUE E



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2° 10°		2° 10°	
G1	0.410	0.430	10.42	10.92
K1	0.040	---	1.02	---

MC10E131, MC100E131

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center
2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051
Phone: 81-3-5773-3850

ON Semiconductor Website: <http://onsemi.com>

Order Literature: <http://www.onsemi.com/litorder>

For additional information, please contact your
local Sales Representative.